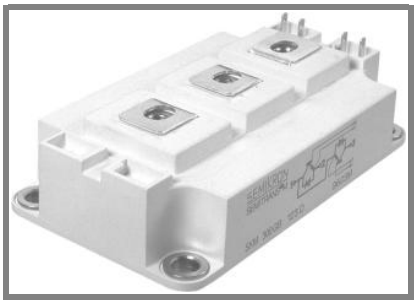
SKM 400GB126D ...



SEMITRANS® 3

Trench IGBT Module

SKM 400GB126D

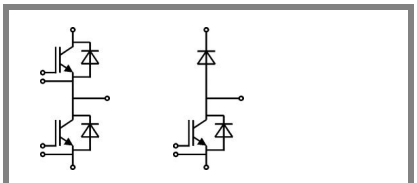
SKM 400GAL126D

Features

- Homogeneous Si
- Trench = Trenchgate technology
- V_{CEsat} with positive temperature coefficient
- High short circuit capability, self limiting to 6 x I_c

Typical Applications*

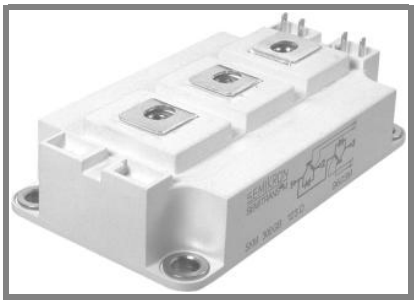
- AC inverter drives
- UPS
- Electronic welders



GB GAL

Absolute Maximum Ratings			T_c = 25 °C, unless otherwise specified	
Symbol	**Conditions**		**Values**	**Units**
IGBT				
V_{CES}	T_j = 25 °C		1200	V
I_C	T_j = 150 °C	T_{case} = 25 °C	470	A
		T_{case} = 80 °C	330	A
I_{CRM}	I_{CRM}=2xI_{Cnom}		600	A
V_{GES}			± 20	V
t_{psc}	V_{CC} = 600 V; $V_{GE} \leq$ 20 V; V_{CES} < 1200 V	T_j = 125 °C	10	µs
Inverse Diode				
I_F	T_j = 150 °C	T_{case} = 25 °C	400	A
		T_{case} = 80 °C	270	A
I_{FRM}	I_{FRM}=2xI_{Fnom}		600	A
I_{FSM}	t_p = 10 ms; sin.	T_j = 150 °C	2200	A
Freewheeling Diode				
I_F	T_j = 150 °C	T_{case} = 25 °C	400	A
		T_{case} = 80 °C	270	A
I_{FRM}	I_{FRM}=2xI_{Fnom}		600	A
I_{FSM}	t_p = 10 ms; sin.	T_j = 150 °C	2200	A
Module				
$I_{t(RMS)}$			500	A
T_{vj}			- 40 ...+ 150	°C
T_{stg}			- 40 ...+ 125	°C
V_{isol}	AC, 1 min.		4000	V

Characteristics			T_c = 25 °C, unless otherwise specified			
Symbol	**Conditions**		**min.**	**typ.**	**max.**	**Units**
IGBT						
$V_{GE(th)}$	V_{GE} = V_{CE}, I_C = 12 mA		5	5,8	6,5	V
I_{CES}	V_{GE} = 0 V, V_{CE} = V_{CES}	T_j = 25 °C		0,15	0,45	mA
V_{CE0}		T_j = 25 °C		1	1,2	V
		T_j = 125 °C		0,9		V
r_{CE}	V_{GE} = 15 V	T_j = 25°C		2,3	3,2	mΩ
		T_j = 125°C		3,7		mΩ
$V_{CE(sat)}$	I_{Cnom} = 300 A, V_{GE} = 15 V	T_j = 25°C$_{chiplev.}$		1,7	2,15	V
		T_j = 125°C$_{chiplev.}$		2		V
C_{ies}				23,1		nF
C_{oes}	V_{CE} = 25, V_{GE} = 0 V	f = 1 MHz		1,9		nF
C_{res}				1,2		nF
Q_G	V_{GE} = -8V ... +20V			2800		nC
R_{Gint}	T_j = °C			2,5		Ω
$t_{d(on)}$	R_{Gon} = 2 Ω	V_{CC} = 600V		330		ns
t_r		I_C= 300A		50		ns
E_{on}		T_j = 125 °C		29		mJ
$t_{d(off)}$	R_{Goff} = 2 Ω	V_{GE} = ±15V		650		ns
t_f				110		ns
E_{off}				48		mJ
$R_{th(j-c)}$	per IGBT				0,08	K/W



SEMITRANS® 3

Trench IGBT Module

SKM 400GB126D

SKM 400GAL126D

Features

- Homogeneous Si
- Trench = Trenchgate technology
- V_{CEsat} with positive temperature coefficient
- High short circuit capability, self limiting to 6 x I_c

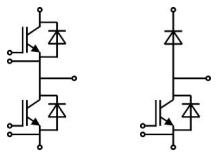
Typical Applications*

- AC inverter drives
- UPS
- Electronic welders

Characteristics						
Symbol	**Conditions**		**min.**	**typ.**	**max.**	**Units**
Inverse Diode						
$V_F = V_{EC}$	I_{Fnom} = 300 A; V_{GE} = 0 V	T_j = 25 °C$_{chiplev.}$		1,6	1,8	V
		T_j = 125 °C$_{chiplev.}$		1,6	1,8	V
V_{F0}		T_j = 25 °C		1	1,1	V
		T_j = 125 °C		0,8	0,9	V
r_F		T_j = 25 °C		2	2,3	mΩ
		T_j = 125 °C		2,7	3	mΩ
I_{RRM}	I_F = 300 A	T_j = 125 °C		390		A
Q_{rr}	di/dt = 6300 A/µs			77		µC
E_{rr}	V_{GE} = -15 V; V_{CC} = 600 V			27		mJ
$R_{th(j-c)D}$	per diode				0,18	K/W
Freewheeling Diode						
$V_F = V_{EC}$	I_{Fnom} = 300 A; V_{GE} = 0 V	T_j = 25 °C$_{chiplev.}$		1,6	1,8	V
		T_j = 125 °C$_{chiplev.}$		1,6	1,8	V
V_{F0}		T_j = 25 °C		1	1,1	V
		T_j = 125 °C		0,8	0,9	V
r_F		T_j = 25 °C		2	2,3	V
		T_j = 125 °C		2,7	3	V
I_{RRM}	I_F = 300 A	T_j = 125 °C		390		A
Q_{rr}	di/dt = 6300 A/µs			77		µC
E_{rr}	V_{GE} = -15 V; V_{CC} = 600 V			27		mJ
$R_{th(j-c)D}$	per diode				0,18	K/W
Module						
L_{CE}				15	20	nH
$R_{CC'+EE'}$	res., terminal-chip	T_{case}= 25 °C		0,35		mΩ
		T_{case}= 125 °C		0,5		mΩ
$R_{th(c-s)}$	per module				0,038	K/W
M_s	to heat sink M6		3		5	Nm
M_t	to terminals M6		2,5		5	Nm
w					325	g

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.



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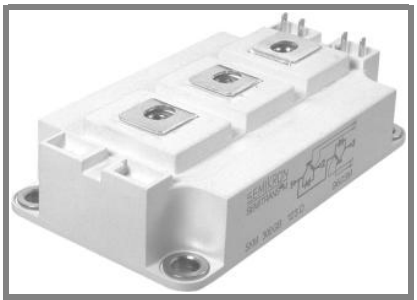

SEMITRANS® 3

Trench IGBT Module

SKM 400GB126D

SKM 400GAL126D

Features

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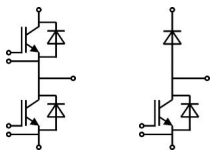
- V_{CEsat} with positive temperature coefficient
- High short circuit capability, self limiting to 6 x I_c

Typical Applications*

- AC inverter drives
- UPS
- Electronic welders

Z_{th} Symbol	Conditions	Values	Units
$Z_{th(j-c)I}$			
R_i	i = 1	55	mk/W
R_i	i = 2	21	mk/W
R_i	i = 3	3,6	mk/W
R_i	i = 4	0,4	mk/W
tau_i	i = 1	0,0393	s
tau_i	i = 2	0,0171	s
tau_i	i = 3	0,002	s
tau_i	i = 4	0,0002	s
$Z_{th(j-c)D}$			
R_i	i = 1	120	mk/W
R_i	i = 2	48	mk/W
R_i	i = 3	10	mk/W
R_i	i = 4	2	mk/W
tau_i	i = 1	0,0262	s
tau_i	i = 2	0,0417	s
tau_i	i = 3	0,0012	s
tau_i	i = 4	0,001	s



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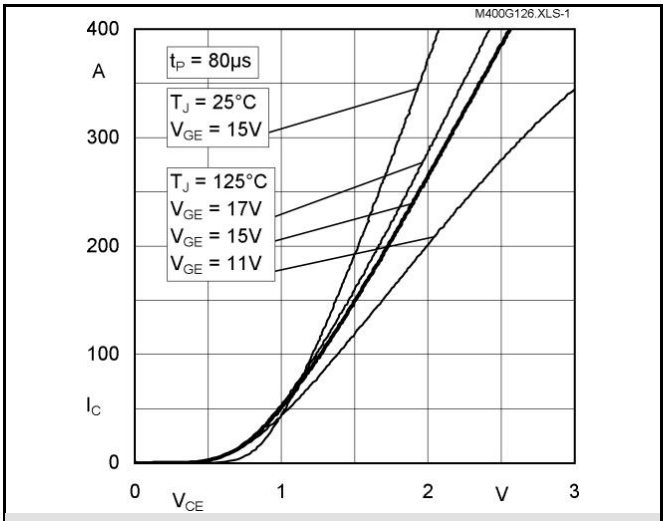

Fig. 1 Typ. output characteristic, inclusive $R_{CC'+ EE'}$

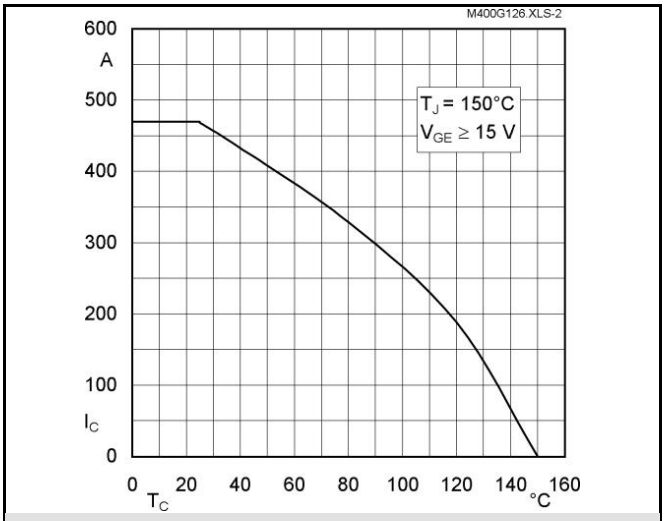

Fig. 2 Rated current vs. temperature $I_C = f(T_C)$

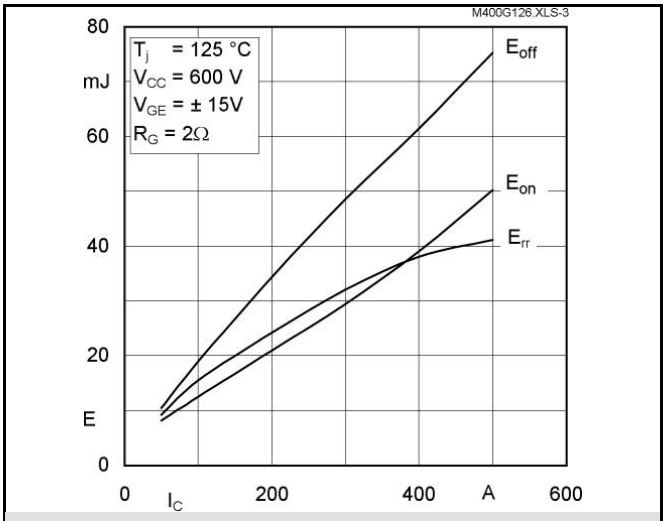

Fig. 3 Typ. turn-on /-off energy = f (I_C)

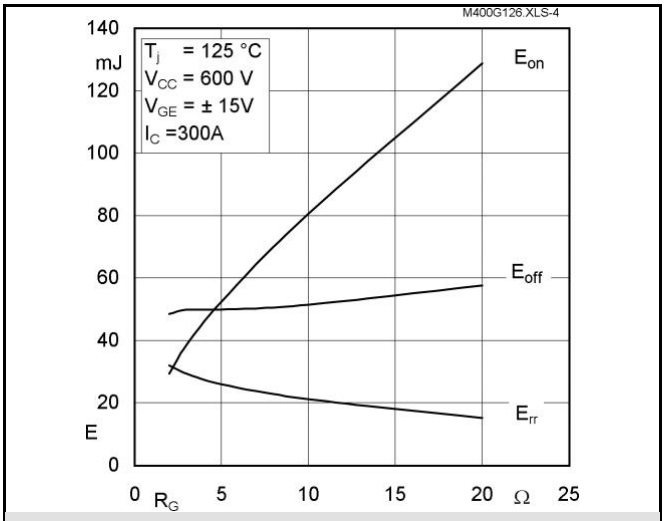

Fig. 4 Typ. turn-on /-off energy = f (R_G)

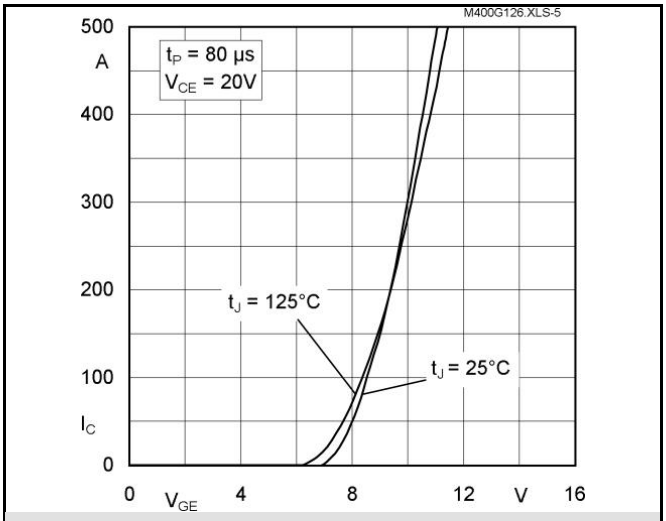

Fig. 5 Typ. transfer characteristic

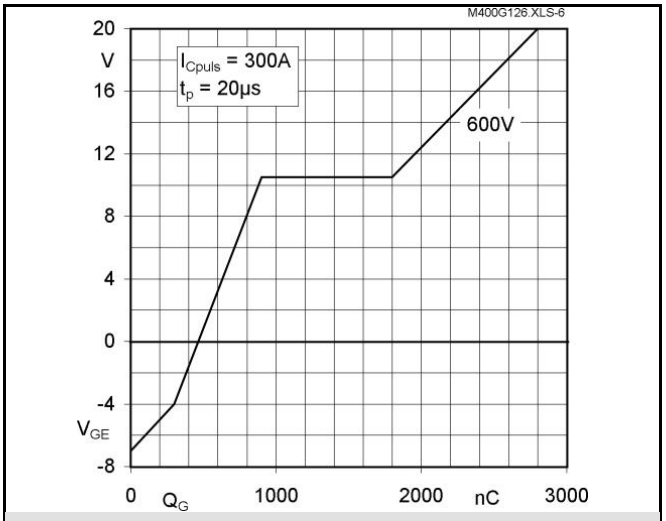

Fig. 6 Typ. gate charge characteristic

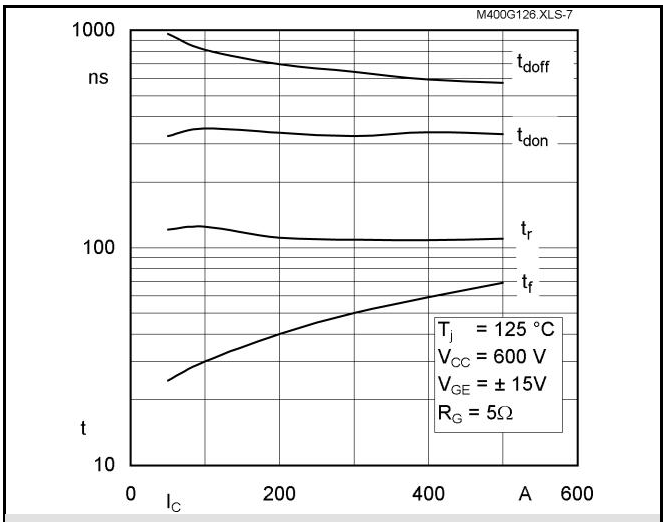

Fig. 7 Typ. switching times vs. I_C

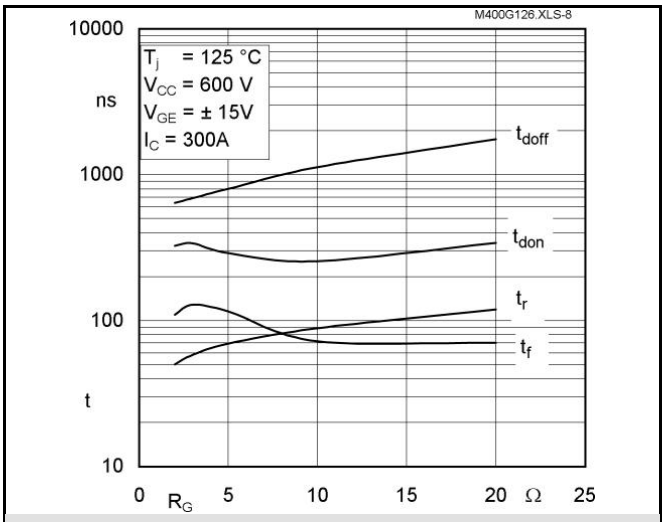

Fig. 8 Typ. switching times vs. gate resistor R_G

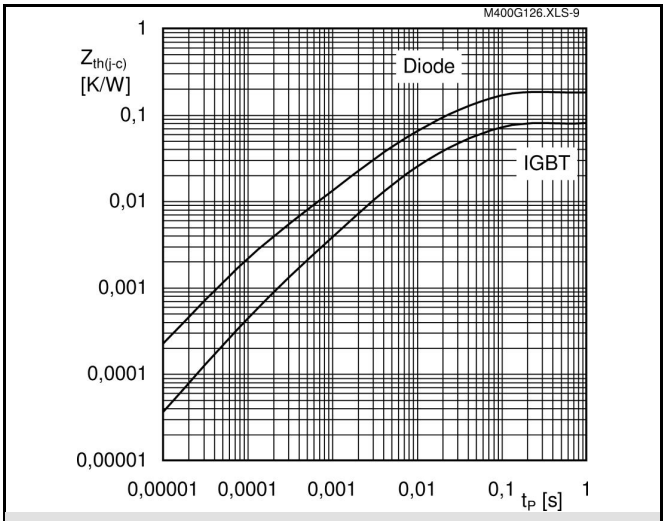

Fig. 9 Transient thermal impedance

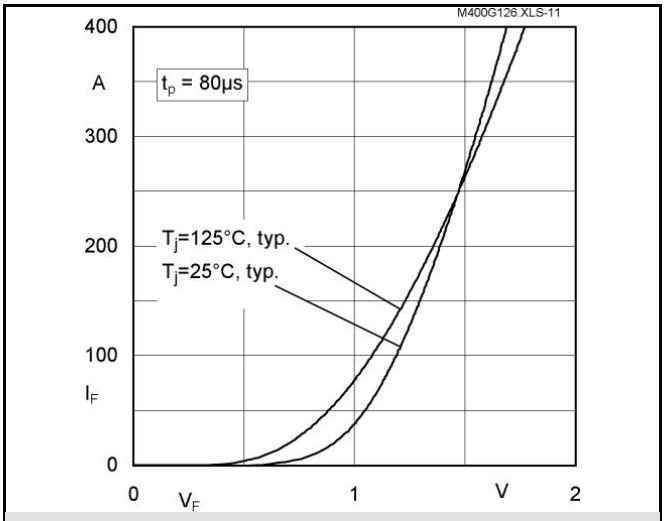

Fig. 10 CAL diode forward characteristic

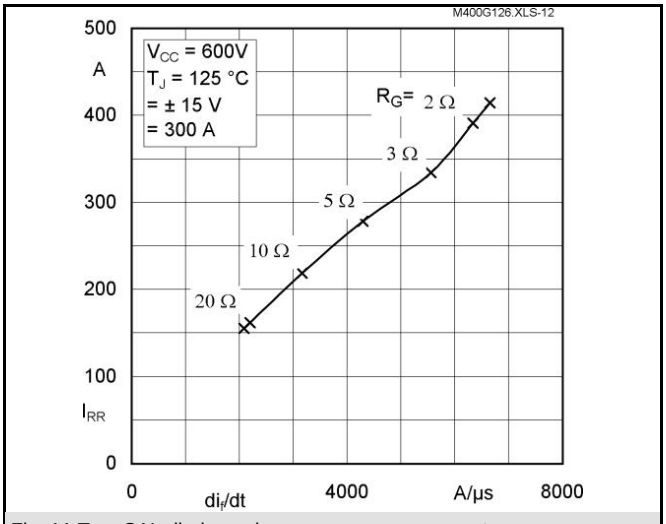

Fig. 11 Typ. CAL diode peak reverse recovery current

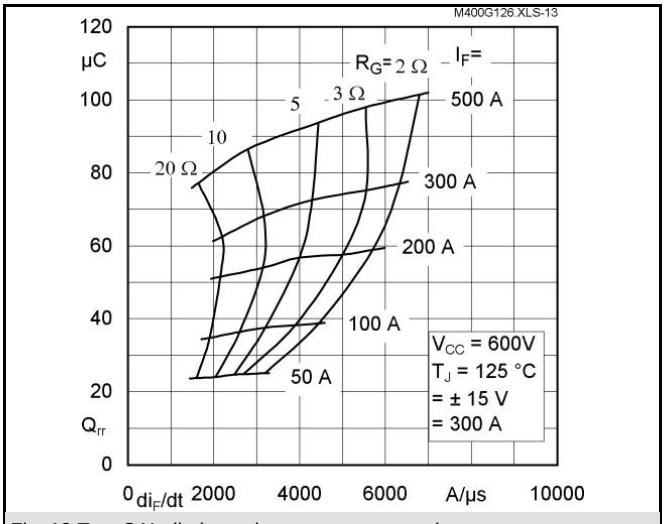

Fig. 12 Typ. CAL diode peak reverse recovery charge

UL Recognized File 63 532

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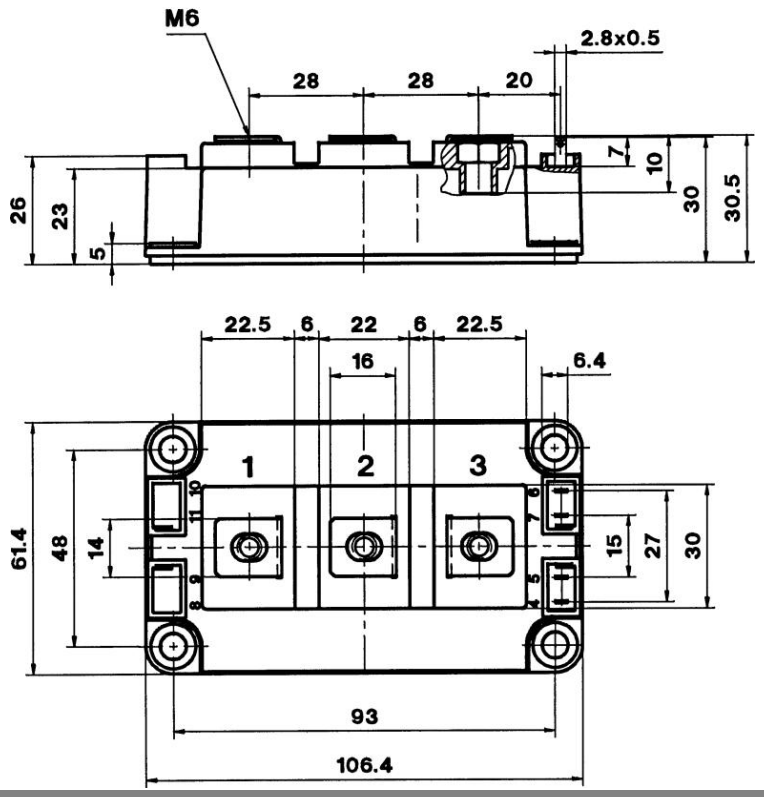
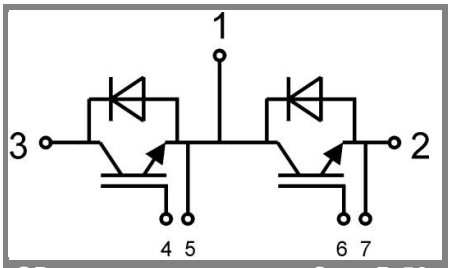
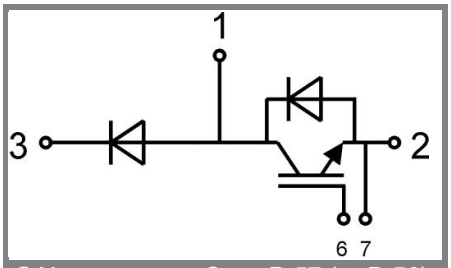


Case D 56



GB Case D 56



GAL Case D 57 (➞ D 56)